MOSFET – Single, N-Channel, Small Signal, SC-88

25 V, 1.2 A

Features

- Advance Planar Technology for Fast Switching, Low RDS(on)
- Higher Efficiency Extending Battery Life
- AEC-Q101 Qualified and PPAP Capable NVJS4405N
- These Devices are Pb-Free and are RoHS Compliant

Applications

- Boost and Buck Converter
- Load Switch
- Battery Protection

MAXIMUM RATINGS (T_J = 25° C unless otherwise noted)

Rating	Symbol	Value	Unit		
Drain-to-Source Voltage			V _{DSS}	25	V
Gate-to-Source Voltage			V _{GS}	± 8.0	V
Drain Current	t < 5 s	$T_A = 25^{\circ}C$	۱ _D	1.2	А
Continuous Drain Current	t Steady State	$T_A = 25^{\circ}C$	I _D	1.0	А
(Note 1)		$T_A = 75^{\circ}C$		0.80	
Power Dissipation (Note 1)	Stead	dy State	PD	0.63	W
Power Dissipation (Note 1)	t≤	≤ 5 s	PD	0.89	W
Pulsed Drain Current	t _p =	10 μs	I _{DM}	3.7	А
Operating Junction and Storage Temperature			T _J , T _{STG}	–55 to +150	°C
Source Current (Body Diode) (Note 1)			۱ _S	0.8	А
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)			ΤL	260	°C
ESD Rating – Machine Model				25	V

THERMAL RESISTANCE RATINGS

Rating	Symbol	Мах	Unit
Junction-to-Lead - Steady State (Note 1)	$R_{\theta JL}$	102	°C/W
Junction-to-Ambient - Steady State (Note 1)	$R_{\theta JA}$	200	
Junction-to-Ambient – t \leq 5 s (Note 1)	$R_{\theta JA}$	140	

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. Surface mounted on FR4 board using 1 in sq pad size

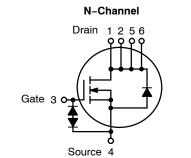
(Cu area = 1.127 in sq [1 oz] including traces).



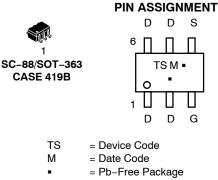
ON Semiconductor®

http://onsemi.com

V _{(BR)DSS}	R _{DS(on)} Typ	I _D Max
25 V	249 mΩ @ 4.5 V	12A
	299 mΩ @ 2.7 V	1.2 A



MARKING DIAGRAM &



(Note: Microdot may be in either location)

ORDERING INFORMATION

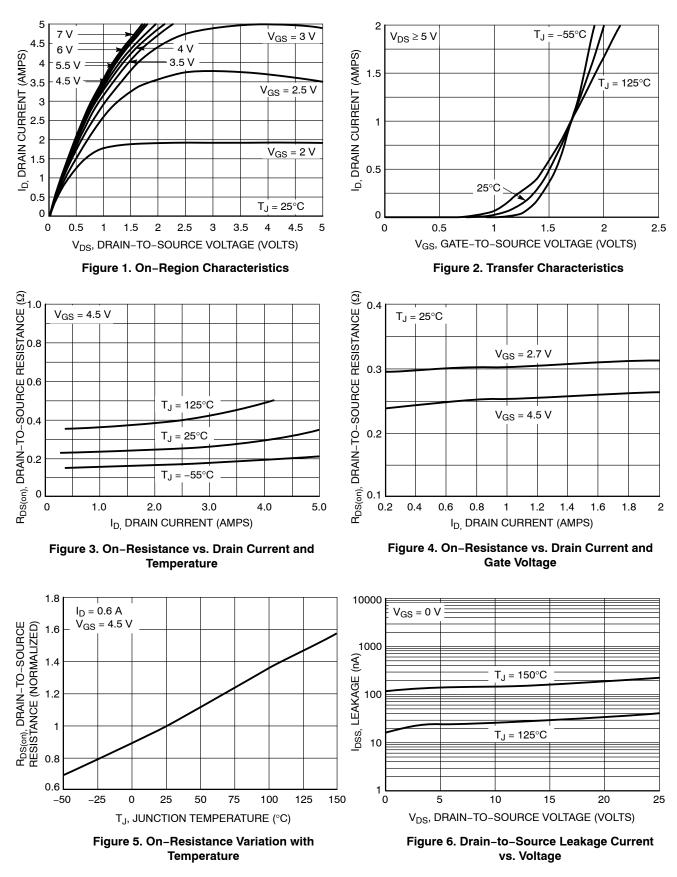
Device		Package	Shipping†
NTJS4405N	IT1G	SC-88 (Pb-Free)	3000 / Tape & Reel
NVJS4405N	IT1G	SC-88 (Pb-Free)	3000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

ELECTRICAL CHARACTERISTICS (T_J = $25^{\circ}C$ unless otherwise noted)

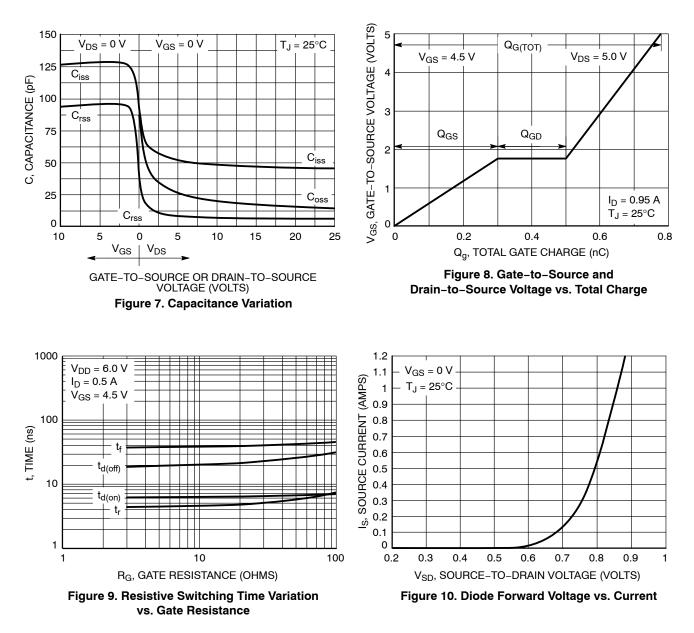
Characteristic	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS					•	-	•
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V_{GS} = 0 V, I _D = 250 μ A		25			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} /T _J				30		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	V _{GS} = 0 V,	$T_J = 25^{\circ}C$			1.0	μA
		$V_{DS} = 20 V$	$T_J = 125^{\circ}C$			10	
Gate-to-Source Leakage Current	I _{GSS}	$V_{DS} = 0 V, V_{C}$	_{is} = 8.0 V			100	nA
ON CHARACTERISTICS (Note 2)							
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}, I_D$	= 250 μA	0.65		1.5	V
Negative Threshold Temperature Coefficient	V _{GS(TH)} /T _J				-2.0		mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	$\label{eq:RDS(on)} \begin{array}{c} V_{GS} = 4.5 \ \text{V}, \ \text{I}_{D} = 0.6 \ \text{A} \\ \hline V_{GS} = 2.7 \ \text{V}, \ \text{I}_{D} = 0.2 \ \text{A} \\ \hline V_{GS} = 4.5 \ \text{V}, \ \text{I}_{D} = 1.2 \ \text{A} \end{array}$			249	350	mΩ
					299	400	
					260		
Forward Transconductance	9fs	V _{DS} = 5.0 V, I _D = 0.5 A			0.5		S
CHARGES AND CAPACITANCES							
Input Capacitance	C _{ISS}	V _{GS} = 0 V, f = 1.0 MHz, V _{DS} = 10 V			49	60	pF
Output Capacitance	C _{OSS}				22.4	30	
Reverse Transfer Capacitance	C _{RSS}				8.0	12	
Total Gate Charge	Q _{G(TOT)}				0.75	1.5	nC
Threshold Gate Charge	Q _{G(TH)}	V _{GS} = 4.5 V, V _I	_{DS} = 5.0 V,		0.10		
Gate-to-Source Charge	Q _{GS}	l _D = 0.9	5 A		0.30	0.50	
Gate-to-Drain Charge	Q _{GD}				0.20	0.40	
SWITCHING CHARACTERISTICS (No	te 3)						
Turn-On Delay Time	t _{d(ON)}				6.0	12	ns
Rise Time	t _r	V_{GS} = 4.5 V, V_{DS} = 6.0 V, I_{D} = 0.5 A, R_{G} = 50 Ω			4.7	8.0	7
Turn-Off Delay Time	t _{d(OFF)}				25	35	
Fall Time	t _f				41	60	
DRAIN-SOURCE DIODE CHARACTE	RISTICS						
Forward Diode Voltage	V _{SD}	V _{GS} = 0 V, I _S = 0.6 A	$T_J = 25^{\circ}C$		0.82	1.20	V

Pulse Test: pulse width ≤ 300 μs, duty cycle ≤ 2%.
Switching characteristics are independent of operating junction temperatures.



TYPICAL PERFORMANCE CURVES (T_J = 25°C unless otherwise noted)

TYPICAL PERFORMANCE CURVES (T_J = 25°C unless otherwise noted)



0.043

0.004





- XXX = Specific Device Code

(Note: Microdot may be in either location)

*Date Code orientation and/or position may vary depending upon manufacturing location.

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.



DIMENSIONS: MILLIMETERS

*For additional information on our Pb-Free strategy and soldering

details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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DATE 11 DEC 2012

STYLE 1: PIN 1. EMITTER 2 2. BASE 2 3. COLLECTOR 1 4. EMITTER 1 5. BASE 1 6. COLLECTOR 2	STYLE 2: CANCELLED	STYLE 3: CANCELLED	STYLE 4: PIN 1. CATHODE 2. CATHODE 3. COLLECTOR 4. EMITTER 5. BASE 6. ANODE	STYLE 5: PIN 1. ANODE 2. ANODE 3. COLLECTOR 4. EMITTER 5. BASE 6. CATHODE	STYLE 6: PIN 1. ANODE 2 2. N/C 3. CATHODE 1 4. ANODE 1 5. N/C 6. CATHODE 2
STYLE 7: PIN 1. SOURCE 2 2. DRAIN 2 3. GATE 1 4. SOURCE 1 5. DRAIN 1 6. GATE 2	STYLE 8: CANCELLED	STYLE 9: PIN 1. EMITTER 2 2. EMITTER 1 3. COLLECTOR 1 4. BASE 1 5. BASE 2 6. COLLECTOR 2	STYLE 10: PIN 1. SOURCE 2 2. SOURCE 1 3. GATE 1 4. DRAIN 1 5. DRAIN 2 6. GATE 2	STYLE 11: PIN 1. CATHODE 2 2. CATHODE 2 3. ANODE 1 4. CATHODE 1 5. CATHODE 1 6. ANODE 2	STYLE 12: PIN 1. ANODE 2 2. ANODE 2 3. CATHODE 1 4. ANODE 1 5. ANODE 1 6. CATHODE 2
STYLE 13:	STYLE 14:	STYLE 15:	STYLE 16:	STYLE 17:	STYLE 18:
PIN 1. ANODE	PIN 1. VREF	PIN 1. ANODE 1	PIN 1. BASE 1	PIN 1. BASE 1	PIN 1. VIN1
2. N/C	2. GND	2. ANODE 2	2. EMITTER 2	2. EMITTER 1	2. VCC
3. COLLECTOR	3. GND	3. ANODE 3	3. COLLECTOR 2	3. COLLECTOR 2	3. VOUT2
4. EMITTER	4. IOUT	4. CATHODE 3	4. BASE 2	4. BASE 2	4. VIN2
5. BASE	5. VEN	5. CATHODE 2	5. EMITTER 1	5. EMITTER 2	5. GND
6. CATHODE	6. VCC	6. CATHODE 1	6. COLLECTOR 1	6. COLLECTOR 1	6. VOUT1
STYLE 19:	STYLE 20:	STYLE 21:	STYLE 22:	STYLE 23:	STYLE 24:
PIN 1. I OUT	PIN 1. COLLECTOR	PIN 1. ANODE 1	PIN 1. D1 (i)	PIN 1. Vn	PIN 1. CATHODE
2. GND	2. COLLECTOR	2. N/C	2. GND	2. CH1	2. ANODE
3. GND	3. BASE	3. ANODE 2	3. D2 (i)	3. Vp	3. CATHODE
4. V CC	4. EMITTER	4. CATHODE 2	4. D2 (c)	4. N/C	4. CATHODE
5. V EN	5. COLLECTOR	5. N/C	5. VBUS	5. CH2	5. CATHODE
6. V REF	6. COLLECTOR	6. CATHODE 1	6. D1 (c)	6. N/C	6. CATHODE
STYLE 25:	STYLE 26:	STYLE 27:	STYLE 28:	STYLE 29:	STYLE 30:
PIN 1. BASE 1	PIN 1. SOURCE 1	PIN 1. BASE 2	PIN 1. DRAIN	PIN 1. ANODE	PIN 1. SOURCE 1
2. CATHODE	2. GATE 1	2. BASE 1	2. DRAIN	2. ANODE	2. DRAIN 2
3. COLLECTOR 2	3. DRAIN 2	3. COLLECTOR 1	3. GATE	3. COLLECTOR	3. DRAIN 2
4. BASE 2	4. SOURCE 2	4. EMITTER 1	4. SOURCE	4. EMITTER	4. SOURCE 2
5. EMITTER	5. GATE 2	5. EMITTER 2	5. DRAIN	5. BASE/ANODE	5. GATE 1
6. COLLECTOR 1	6. DRAIN 1	6. COLLECTOR 2	6. DRAIN	6. CATHODE	6. DRAIN 1

Note: Please refer to datasheet for style callout. If style type is not called out in the datasheet refer to the device datasheet pinout or pin assignment.

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